# CRMKGL0604A

### N-Channel 60V, 3.8mΩ Typ. Power MOSFET

### **Description**

### **Features**

• 60V, 91A

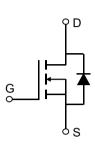
$$R_{DS(ON)}$$
 Typ = 3.8m $\Omega$  @  $V_{GS}$  = 10V

$$R_{DS(ON)}$$
 Typ = 5m $\Omega$  @  $V_{GS}$  = 4.5V

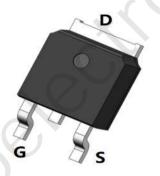
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

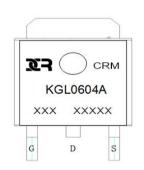
## **Application**

- Load Switch
- PWM Application
- Power Management









**Marking and Pin Assignment** 

### **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKGL0604A	CRMKGL0604A	TO-252-3L	TAPING	13"	2500	25000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		60	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	91	Α
I <sub>D</sub>		T <sub>C</sub> = 100°C	54.6	Α
$I_{DM}$	Pulsed Drain Current (1)		364	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		127	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	69.4	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1.8	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

# CRMKGL0604A

## N-Channel 60V, 3.8mΩ Typ. Power MOSFET

### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.7	2.5	V
Б	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10V, I_D = 20A$	-	3.8	4.9	mΩ
$R_{DS(ON)}$		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A	-	5	6.5	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			2000	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 30V,$ f = 1MHz	X-\	660	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 – 1101112		28	-	pF
$Q_g$	Total Gate Charge		<b>J</b> .	35	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_{D} = 20A$	-	10	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> - 30 V, I <sub>D</sub> - 20A	-	7	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime	.r ()	-	12	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	34	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_{D}$ = 20A, $R_{GEN}$ = 4.5 $\Omega$	-	25	-	ns
$t_{f}$	Turn-Off Fall Time		-	30	-	ns
Drain-So	urce Diode Characteristics and N	Max Ratings				
I <sub>s</sub>	Maximum Continuous Drain to Source Diode Forward Current			-	91	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	364	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 004 - 11/11 - 4004/	-	38	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$ , di/dt = 100A/us	-	23	_	nC

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =22.5A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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### **Test Circuit**

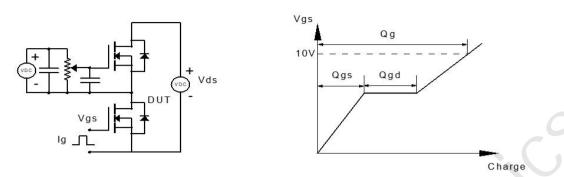


Figure 1: Gate Charge Test Circuit & Waveform

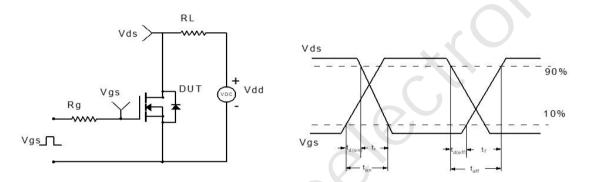


Figure 2: Resistive Switching Test Circuit & Waveform

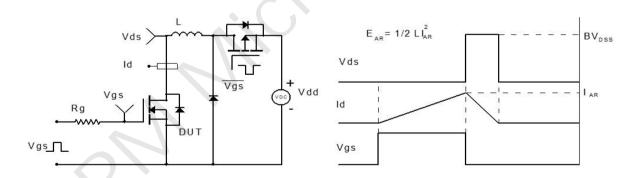


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

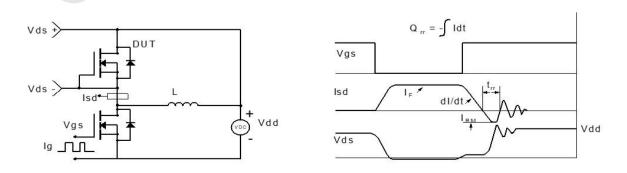
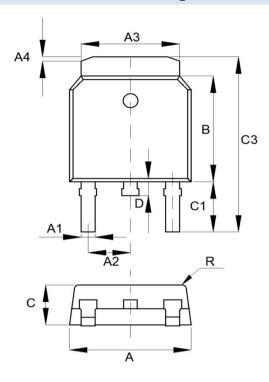


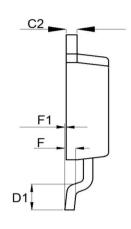
Figure 4: Diode Recovery Test Circuit & Waveform





## Package Mechanical Data(TO-252-3L)





SYMBOL	MIN	NOM	MAX
Α	6.550	6.600	6.650
A1	0.640	0.690	0.740
A2		2.286	
А3	5.234	5.334	5.434
A4	0.070	0.270	0.470
В	6.050	6.100	6.150
С	2.250	2.300	2.350
C1	2.650	2.780	2.950
C2	0.504	0.508	0.510
C3	9.750	9.850	10.00
О	0.700	0.800	0.900
D1	1.400	1.500	1.600
F		0.508	
F1	0	0.050	0.100
R		0.250	.—

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### **Contact information**

For more information, please visit: http://www.crm-semi.tech For sales information, please send an email to: sales@crm-semi.com